

01 1015

GAAS MMIC SP8T NON-REFLECTIVE SWITCH, DC - 2.5 GHz

Typical Applications

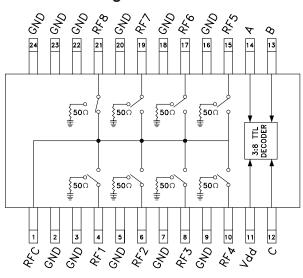
The HMC253AQS24 / HMC253AQS24E is ideal for DC - 2.5 GHz applications:

- CATV/DBS
- CDMA
- Cellular/PCS

Features

Low Insertion Loss (2 GHz): 1.1dB Single Positive Supply: Vdd = +5V Integrated 3:8 TTL Decoder 24 Lead QSOP Package

Functional Diagram



General Description

The HMC253AQS24 & HMC253AQS24E are low-cost non-reflective SP8T switches in 24-lead QSOP packages featuring wideband operation from DC to 2.5 GHz. The switch offers a single positive bias and true TTL/CMOS compatibility. A 3:8 decoder is integrated on the switch requiring only 3 control lines and a positive bias to select each path. The HMC253AQS24 & HMC253AQS24E SP8T will replace multiple configurations of SP4T and SPDT MMIC switches.

Electrical Specifications,

 $T_{A} = +25^{\circ}$ C, For TTL Control and Vdd = +5V in a 50 Ohm system

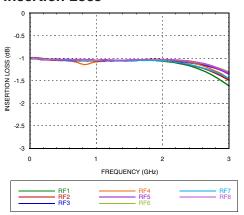
Parameter		Frequency	Min.	Тур.	Max.	Units
Insertion Loss		DC - 1.0 GHz DC - 2.0 GHz DC - 2.5 GHz		1.0 1.1 1.4	1.5 1.7 2.1	dB dB dB
Isolation		DC - 1.0 GHz DC - 2.0 GHz DC - 2.5 GHz	35 30 28	40 35 33		dB dB dB
Return Loss	"On State"	DC - 1.0 GHz DC - 2.0 GHz DC - 2.5 GHz		21 20 16		dB dB dB
Return Loss (RF1-8)	"Off State"	0.3 - 2.5 GHz 0.5 - 2.5 GHz		8 13		dB dB
Input Power for 1 dB Compression		0.3 - 2.5 GHz	20	23		dBm
Input Third Order Intercept (Two-Tone Input Power = +10 dBm Each Tone)		0.3 - 2.5 GHz	41	46		dBm
Switching Characteristics		0.3 - 2.5 GHz				
tRISE, tFALL (10/90% RF) tON, tOFF (50% CTL to 10/90% RF)				20 90		ns ns



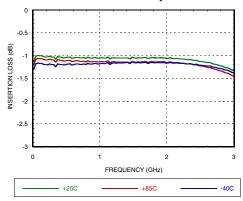
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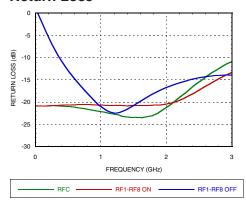
Insertion Loss



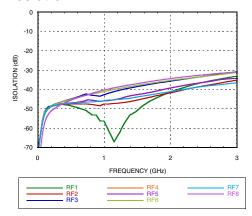
Insertion Loss vs. Temperature



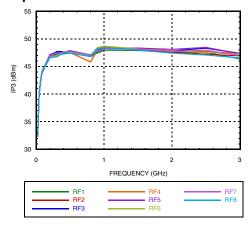
Return Loss



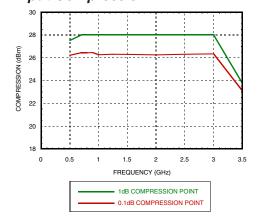
Isolation



Input IP3



Input Compression





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Bias Voltage & Current

Vdd Range = +5 Vdc ± 10%			
Vdd (Vdc)	Idd (Typ.) (mA)	Idd (Max.) (mA)	
+5	4.5	7.5	

TTL/CMOS Control Voltages

State	Bias Condition
Low	0 to +0.8 Vdc @ <1 μA Typ.
High	+2.0 to +5 Vdc @ 60 μA Typ.

Truth Table

Control Input			Signal Path State
А	В	С	RFCOM to:
Low	Low	Low	RF1
High	Low	Low	RF2
Low	High	Low	RF3
High	High	Low	RF4
Low	Low	High	RF5
High	Low	High	RF6
Low	High	High	RF7
High	High	High	RF8

NOTE:

DC Blocking capacitors are required at ports RFC and RF1, 2, 3, 4, 5, 6, 7, 8.



ELECTROSTATIC SENSITIVE DEVICE OBSERVE HANDLING PRECAUTIONS

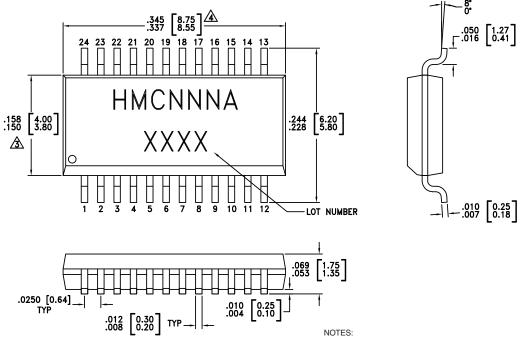
Absolute Maximum Ratings

	F	
Bias Voltage Range (Port Vdd)	+7.0 Vdc	
Control Voltage Range (A, B, C)	-0.5V to Vdd +1Vdc	
Channel Temperature	150 °C	
Thermal Resistance		
(channel to package ground paddle)		
Through Path	183 °C/W	
Termination Path	274 °C/W	
Storage Temperature	-65 to +150 °C	
Storage remperature	-03 10 +130 0	
Operating Temperature	-40 to +85 °C	
Maximum Input Power		
(Vdd = +5V)		
Through Path	+20 dBm (0.05 - 0.5 GHz)	
2.19	+25 dBm (0.5 - 2.5 GHz)	
Terminated Path	+20 dBm (0.05 - 0.5 GHz)	
Tommatou Faur	+23.5 dBm (0.5 - 2.5 GHz)	
500 0 W W (UDA)		
ESD Sensitivity (HBM)	Class 1A	



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Outline Drawing



- 1. LEADFRAME MATERIAL: COPPER ALLOY
- 2. DIMENSIONS ARE IN INCHES [MILLIMETERS].
- DIMENSION DOES NOT INCLUDE MOLDFLASH OF 0.15mm PER SIDE.
- $\overline{\underline{\mathbb{A}}}$ DIMENSION DOES NOT INCLUDE MOLDFLASH OF 0.25mm PER SIDE.
- 5. ALL GROUND LEADS MUST BE SOLDERED TO PCB RF GROUND.

Package Information

Part Number	Package Body Material	Leadframe Plating	MSL Rating	Package Marking [3]
HMC253AQS24	Low Stress Injection Molded Plastic Silica and Silicon Impregnated	Sn/Pb Solder	MSL1 [1]	HMC253A XXXX
HMC253AQS24E RoHS-compliant Low Stress Injection Molded Plastic Silica and Silicon Impregnated		100% Matte Tin	MSL1 [2]	HMC253A XXXX

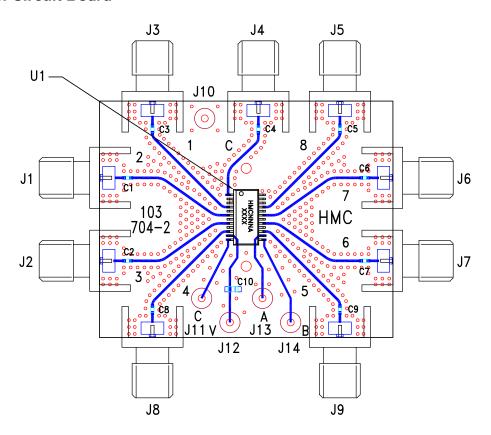
- [1] Max peak reflow temperature of 235 °C
- [2] Max peak reflow temperature of 260 °C
- [3] 4-Digit lot number XXXX



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Evaluation Circuit Board



List of Materials for Evaluation PCB EV1HMC253AQS24[1]

Item	Description
J1 - J9	PCB Mount SMA Connector
J10 - J14	DC Pin
C1 - C9	100 pF Capacitor, 0402 Pkg.
C10	0.01 uF Capacitor, 0603 Pkg.
U1	HMC253AQS24 / HMC253AQS24E SP8T Switch
PCB [2]	103704 Eval Board

^[1] Reference this number when ordering complete evaluation PCB

The circuit board used in the application should be generated with proper RF circuit design techniques. Signal lines at the RF ports should have 50 ohm impedance while the package ground leads should be connected directly to the ground plane similar to that shown above. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation circuit board shown above is available from Analog Devices upon request.

^[2] Circuit Board Material: Rogers 4350

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BGS1414MN20E6327XTSA1 BGS1515MN20E6327XTSA1 BGSA11GN10E6327XTSA1 BGSX28MA18E6327XTSA1 HMC199AMS8
SKY13374-397LF SKY13453-385LF CG2415M6-C2 HMC986A-SX SW-314-PIN UPG2162T5N-E2-A SKY13416-485LF
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